Features

- High Density Cell Design for Ultra Low $R_{DS(on)}$
- Moisture Sensitivity Level 1
- Halogen Free. “Green” Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

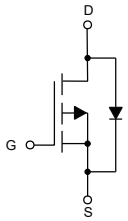
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 306°C/W Junction to Ambient (Note 2)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DS}	-60	V
Gate-Source Volltage		V_{GS}	±30	V
Continuous Drain Current	T_A=25°C	I_D	-0.16	A
	T_A=100°C		-0.1	
Pulsed Drain Current (Note 3)		I_{DM}	-0.64	A
Total Power Dissipation (Note 4)		P_D	400	mW

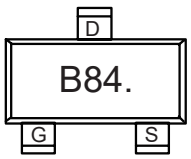
Note:

1. Halogen free "Green” products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking Code

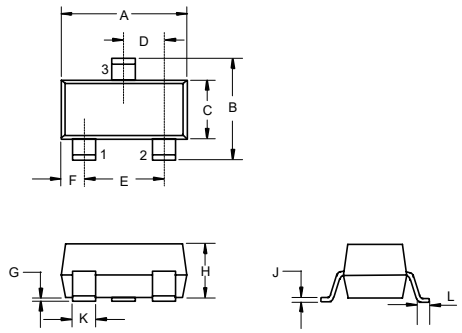


1. GATE
2. SOURCE
3. DRAIN



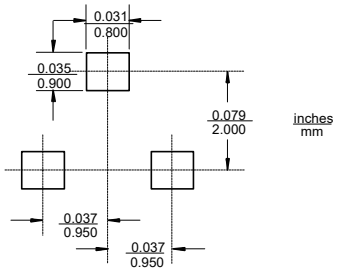
P-Channel MOSFET

SOT-23



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.110	0.120	2.80	3.04	
B	0.083	0.104	2.10	2.64	
C	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
H	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

Suggested Solder Pad Layout



Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D=-250μA	-60			V
Gate-Source Leakage Current	I_{GSS}	V_{DS}=0V, V_{GS} =±30V			±500	nA
		V_{DS}=0V, V_{GS} =±20V			±100	
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-60V, V_{GS}=0V			-1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250μA	-0.9	-1.3	-2.0	V
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=-10V, I_D=-0.15A		2.9	7.8	Ω
		V_{GS}=-4.5V, I_D=-0.15A		3.4	9.5	
Gate Resistance	R_g	f=1 MHz, Open drain		24		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				-0.16	A
Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_S=-0.17A			-1.2	V
Reverse Recovery Time	t_{rr}	I_F=-0.15A,di/dt=100A/μs		23		ns
Reverse Recovery Charge	Q_{rr}			13		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	V_{DS}=-30V,V_{GS}=0V,f=1MHz		27		pF
Output Capacitance	C_{oss}			6		
Reverse Transfer Capacitance	C_{rss}			3.3		
Total Gate Charge	Q_g	V_{DS}=-30V,V_{GS}=-10V,I_D=-1A		1.8		nC
Gate-Source Charge	Q_{gs}			0.6		
Gate-Drain Charge	Q_{gd}			0.8		
Turn-On Delay Time	$t_{d(on)}$	V_{DS}=-30V, V_{GS}=-4.5V, R_G=2.5Ω, I_D=-0.15A		8.6		ns
Turn-On Rise Time	t_r			20		
Turn-Off Delay Time	$t_{d(off)}$			15		
Turn-Off Fall Time	t_f			77		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

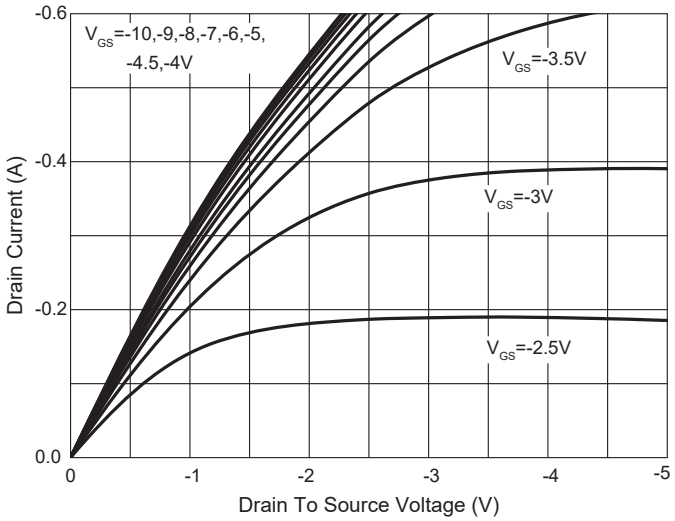


Fig. 2 - Transfer Characteristics

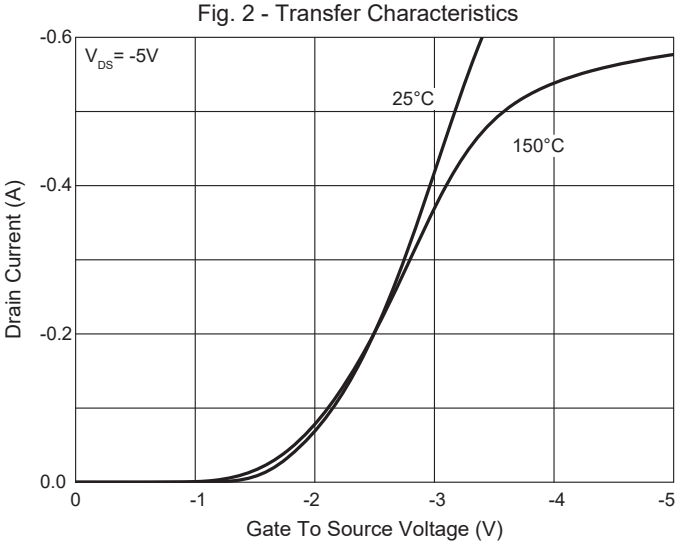


Fig.3-$R_{DS(ON)}$-V_{GS}

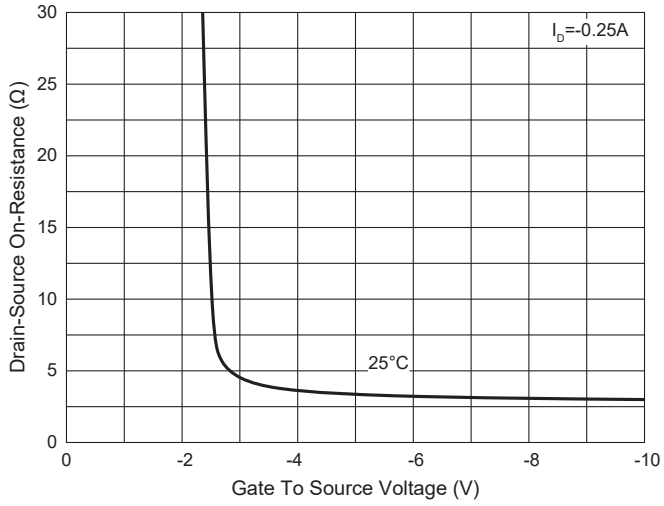


Fig.4-$R_{DS(ON)}$-I_D

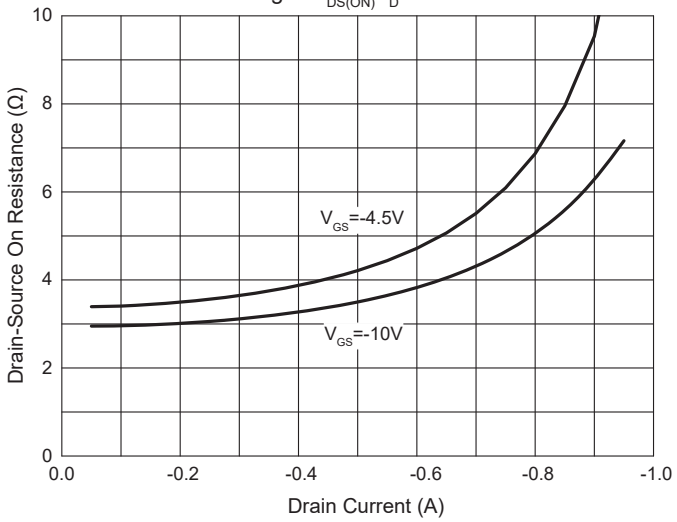


Fig. 5 - Capacitance Characteristics

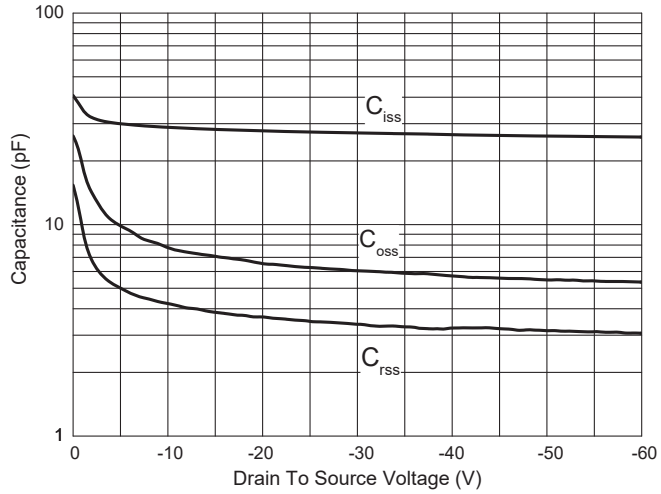
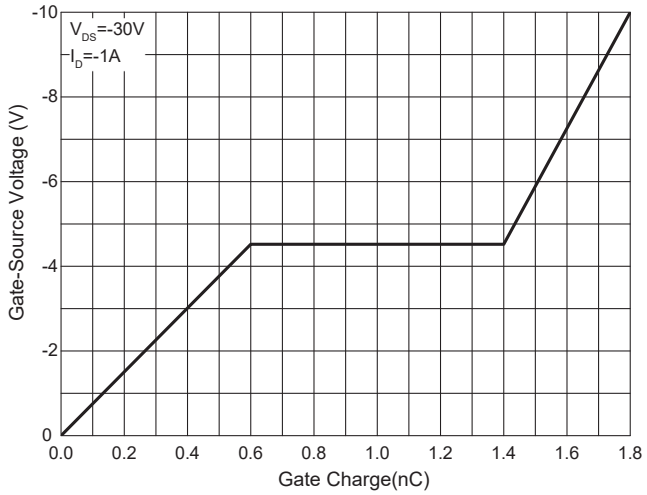


Fig. 6 - Gate Charge



Curve Characteristics

Fig. 7 - Normalized Threshold Voltage

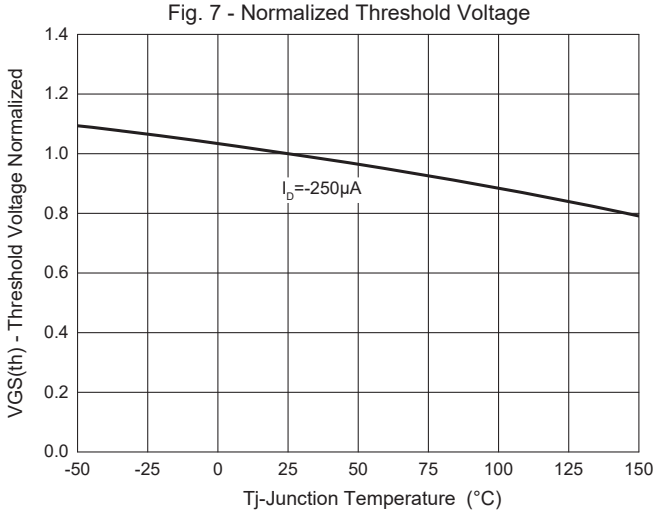


Fig. 8 - Normalized On Resistance Characteristics

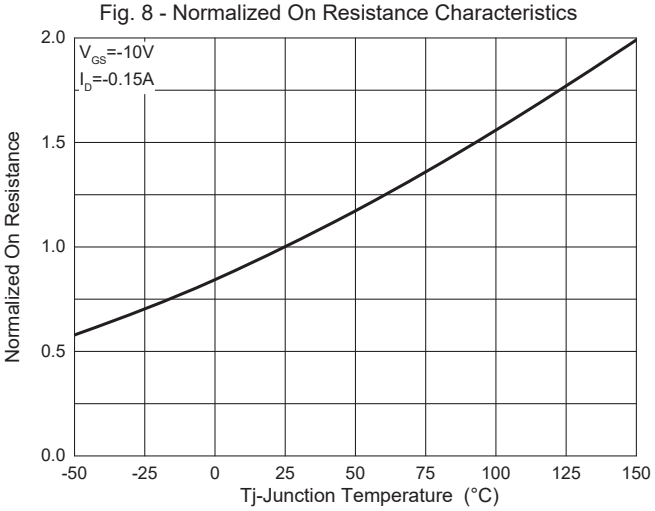


Fig.9-I_S-V_{SD}

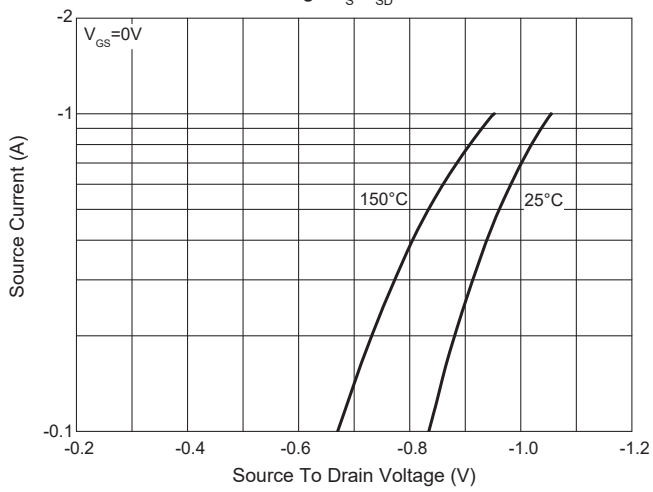


Fig. 10 - Drain Current

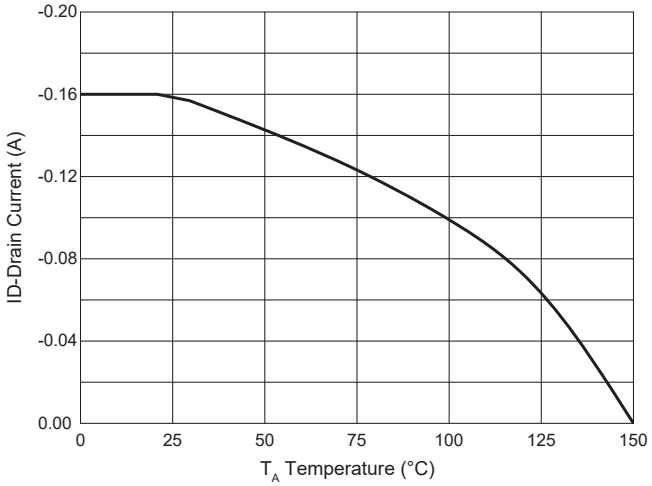
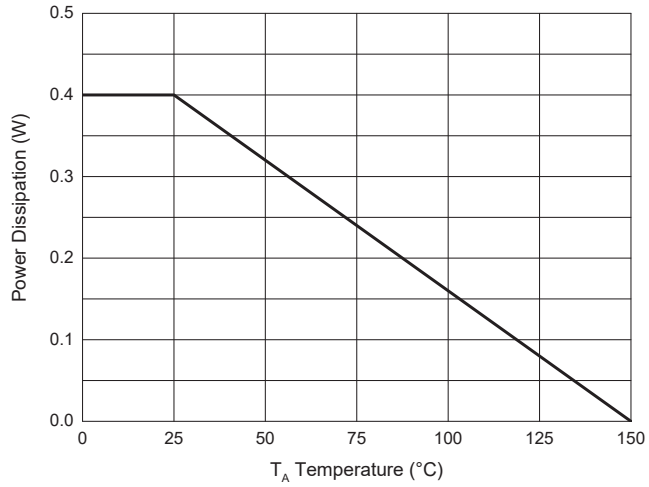


Fig. 11 - PD Dissipation



Curve Characteristics

Fig. 12 - Safe Operation Area

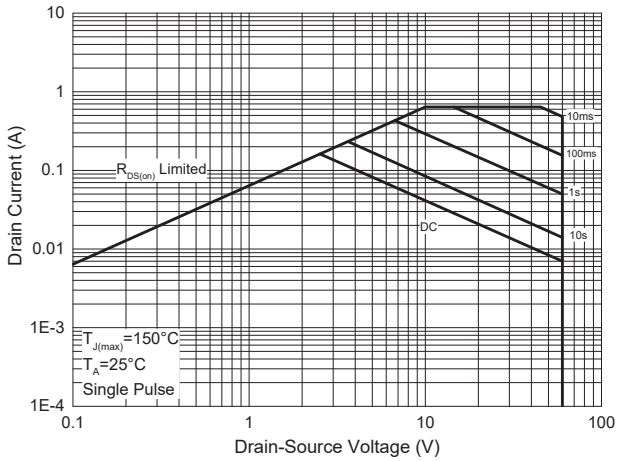
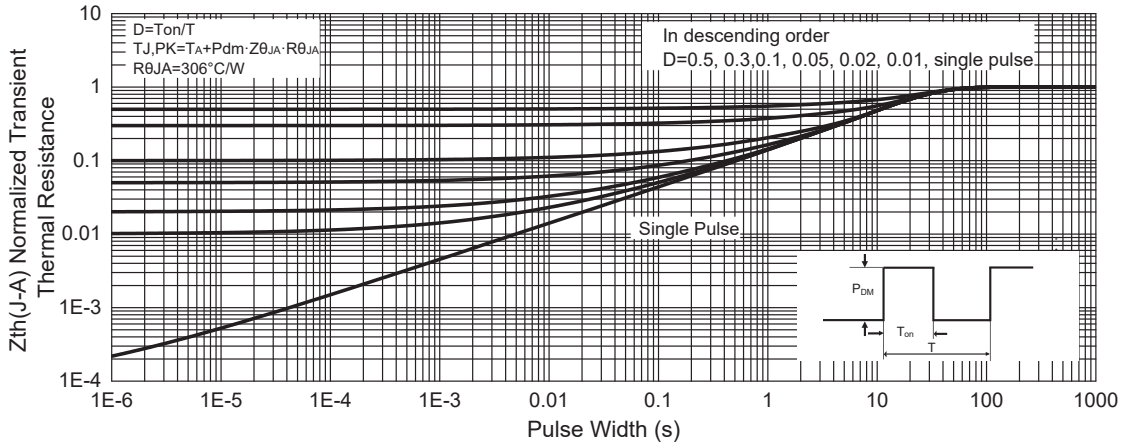


Fig. 13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel
Part Number-13P	Tape&Reel: 10Kpcs/Reel

For packaging details,go to our website at https://www.mccsemi.com/pdf/productpackaging/SOT-23%20Package.pdf

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